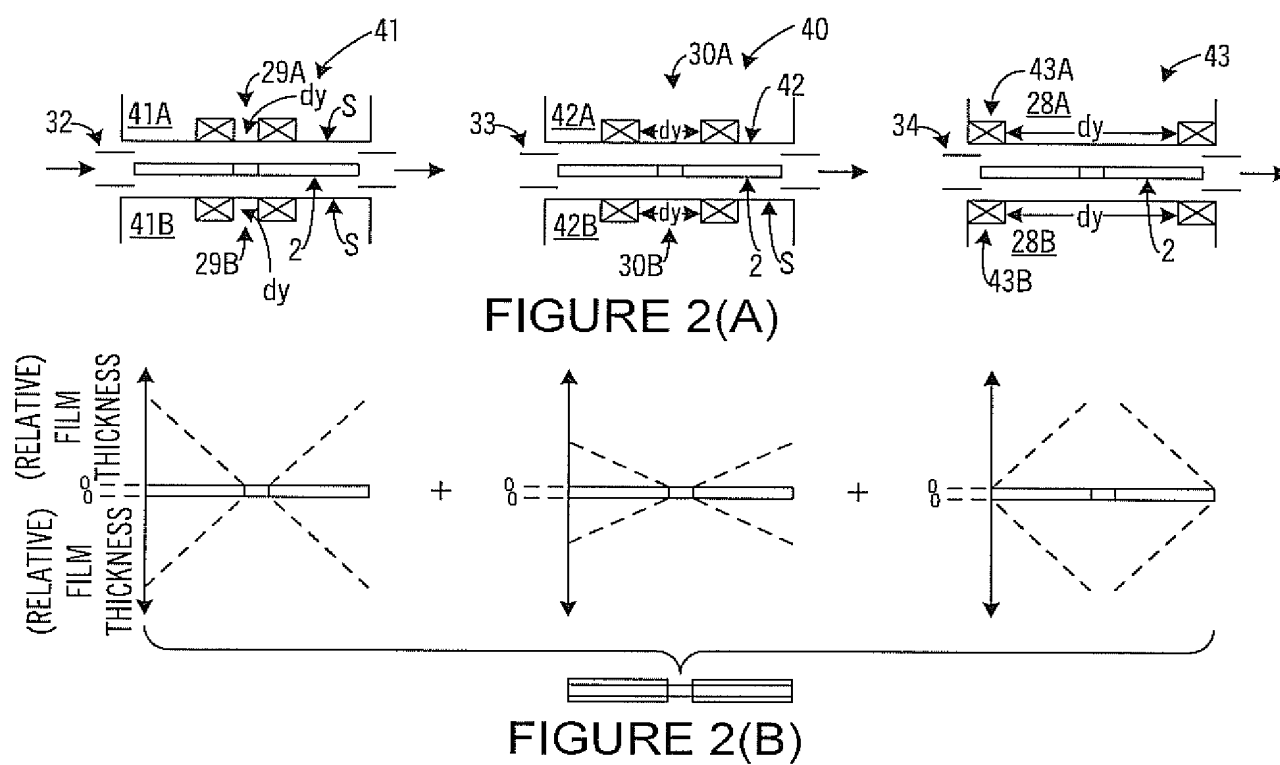
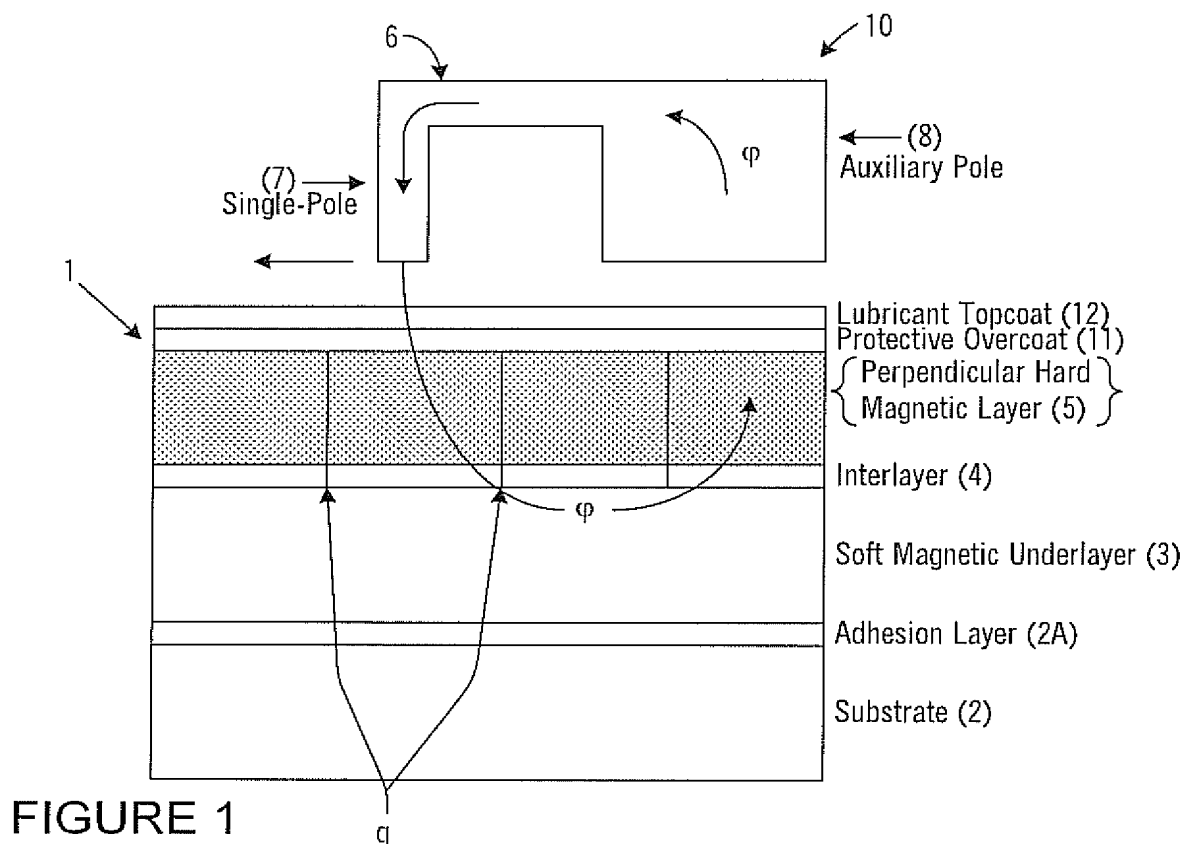


TITLE: METHOD & APPARATUS FOR MULTI-STAGE SPUTTER DEPOSITION OF UNIFORM THICKNESS LAYERS

INVENTOR: Rajiv Yadav Ranjan

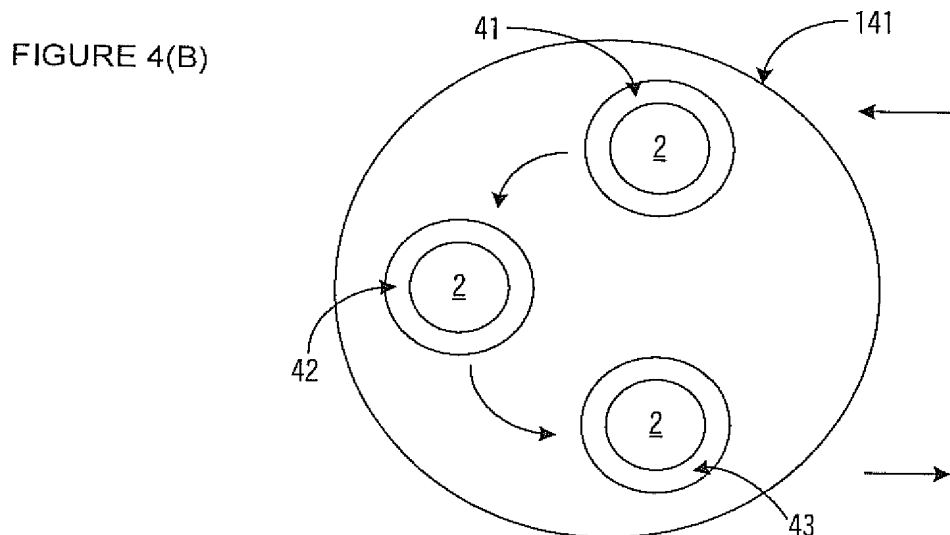
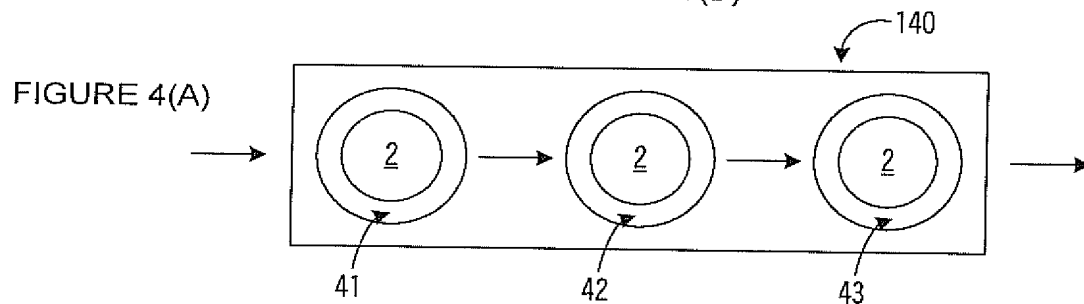
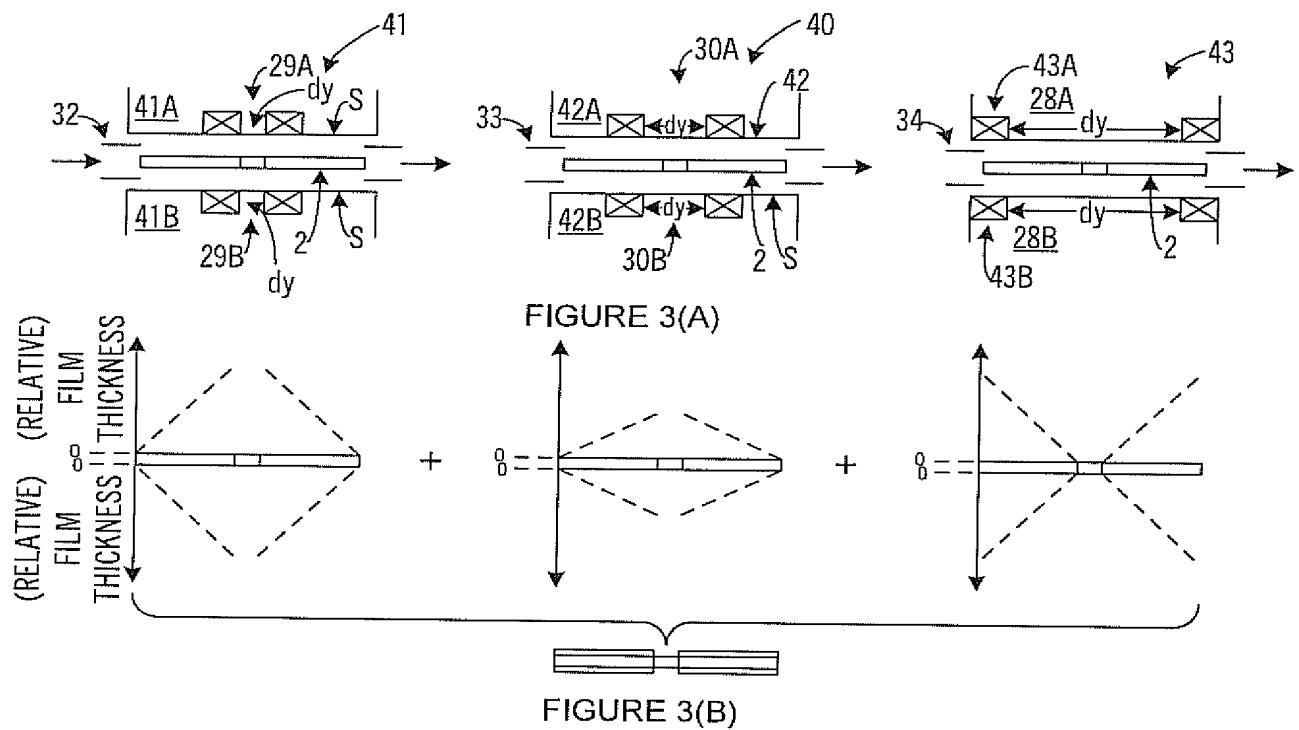
USSN: 10/776,203 ATTORNEY DOCKET #: SEAG-STL-3394



TITLE: METHOD & APPARATUS FOR MULTI-STAGE SPUTTER DEPOSITION OF UNIFORM THICKNESS LAYERS

INVENTOR: Rajiv Yadav Ranjan

USSN: 10/776,203 ATTORNEY DOCKET #: SEAG-STL-3394



3/3

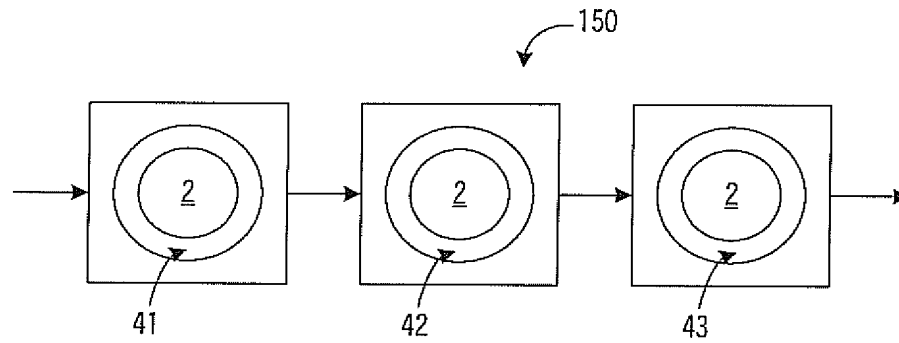


FIGURE 5(A)

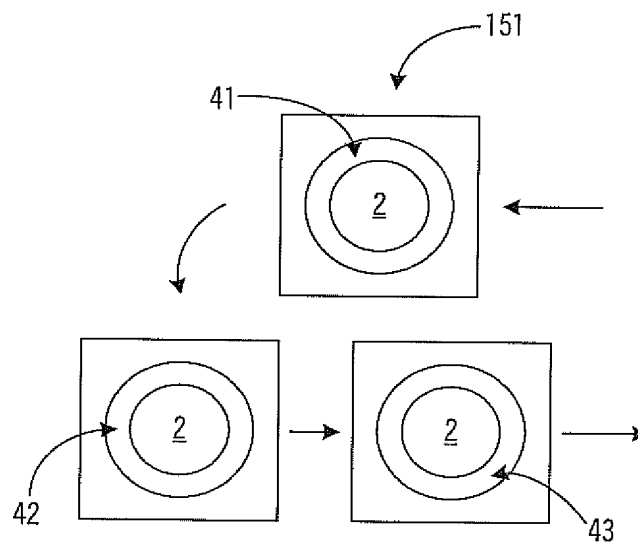


FIGURE 5(B)